

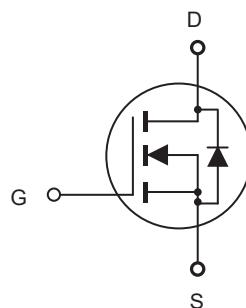


# CED04N7B/CEU04N7B

## N-Channel Enhancement Mode Field Effect Transistor

### FEATURES

- 750V@ $T_J$  max, 3.5A,  $R_{DS(ON)}$  = 3.2Ω @ $V_{GS}$  = 10V.
- Super high dense cell design for extremely low  $R_{DS(ON)}$ .
- High power and current handing capability.
- Pb-free lead plating ; RoHS compliant.
- Halogen Free.
- TO-251 & TO-252 package.



### ABSOLUTE MAXIMUM RATINGS $T_C$ = 25°C unless otherwise noted

Parameter	Symbol	Limit	Units
Drain-Source Voltage	$V_{DS}$	700	V
Gate-Source Voltage	$V_{GS}$	$\pm 30$	V
Drain Current-Continuous @ $T_C$ = 25°C @ $T_C$ = 100°C	$I_D$	3.5	A
		2	A
Drain Current-Pulsed <sup>a</sup>	$I_{DM}$	14	A
Maximum Power Dissipation @ $T_C$ = 25°C - Derate above 25°C	$P_D$	54	W
		0.43	W/°C
Single Pulsed Avalanche Energy <sup>d</sup>	$E_{AS}$	72.2	mJ
Single Pulsed Avalanche Current <sup>d</sup>	$I_{AS}$	3.8	A
Operating and Store Temperature Range	$T_J, T_{stg}$	-55 to 150	°C

### Thermal Characteristics

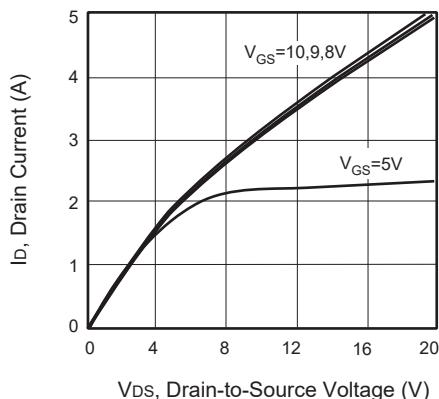
Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2.3	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	50	°C/W



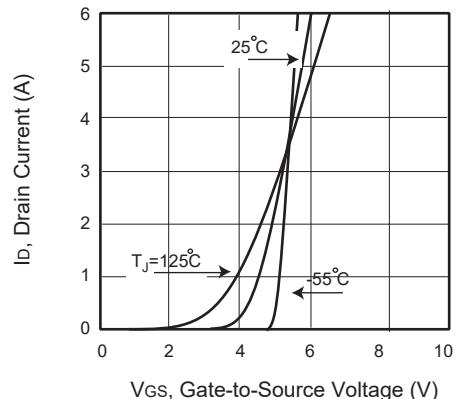
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## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

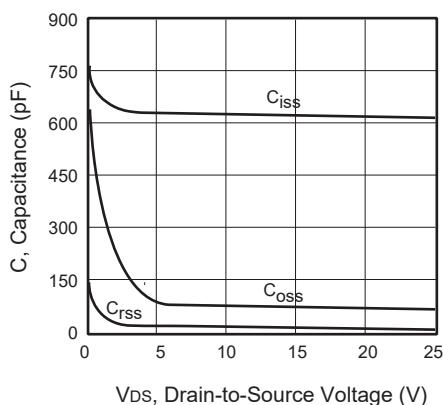
Parameter	Symbol	Test Condition	Min	Typ	Max	Units
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	700			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 700\text{V}, V_{\text{GS}} = 0\text{V}$			1	$\mu\text{A}$
Gate Body Leakage Current, Forward	$I_{\text{GSSF}}$	$V_{\text{GS}} = 30\text{V}, V_{\text{DS}} = 0\text{V}$			100	nA
Gate Body Leakage Current, Reverse	$I_{\text{GSSR}}$	$V_{\text{GS}} = -30\text{V}, V_{\text{DS}} = 0\text{V}$			-100	nA
<b>On Characteristics</b> <sup>b</sup>						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}} = V_{\text{DS}}, I_D = 250\mu\text{A}$	2		4	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 2\text{A}$		2.7	3.2	$\Omega$
<b>Dynamic Characteristics</b> <sup>c</sup>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = 25\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$		615		pF
Output Capacitance	$C_{\text{oss}}$			75		pF
Reverse Transfer Capacitance	$C_{\text{rss}}$			15		pF
<b>Switching Characteristics</b> <sup>c</sup>						
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 300\text{V}, I_D = 4\text{A}, V_{\text{GS}} = 10\text{V}, R_{\text{GEN}} = 25\Omega$		28		ns
Turn-On Rise Time	$t_r$			16		ns
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$			39		ns
Turn-Off Fall Time	$t_f$			19		ns
Total Gate Charge	$Q_g$	$V_{\text{DS}} = 300\text{V}, I_D = 4\text{A}, V_{\text{GS}} = 10\text{V}$		10.4		nC
Gate-Source Charge	$Q_{\text{gs}}$			2.7		nC
Gate-Drain Charge	$Q_{\text{gd}}$			3.2		nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Drain-Source Diode Forward Current	$I_S$				3.5	A
Drain-Source Diode Forward Voltage <sup>b</sup>	$V_{\text{SD}}$	$V_{\text{GS}} = 0\text{V}, I_S = 3.5\text{A}$			1.4	V
<b>Notes :</b>						
a.Repetitive Rating : Pulse width limited by maximum junction temperature.						
b.Pulse Test : Pulse Width $\leq 300\mu\text{s}$ , Duty Cycle $\leq 2\%$ .						
c.Guaranteed by design, not subject to production testing.						
d.L =10mH, $I_{AS} = 3.8\text{A}$ , $V_{DD} = 50\text{V}$ , $R_G = 25\Omega$ , Starting $T_J = 25^\circ\text{C}$ .						



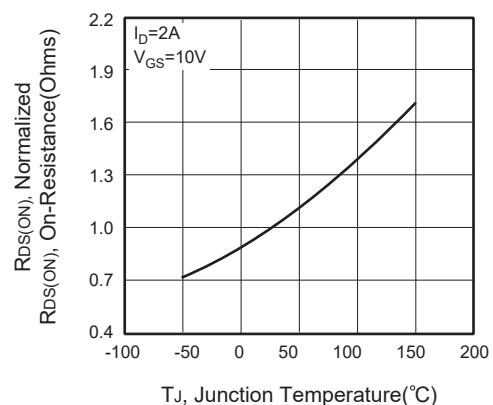
**Figure 1. Output Characteristics**



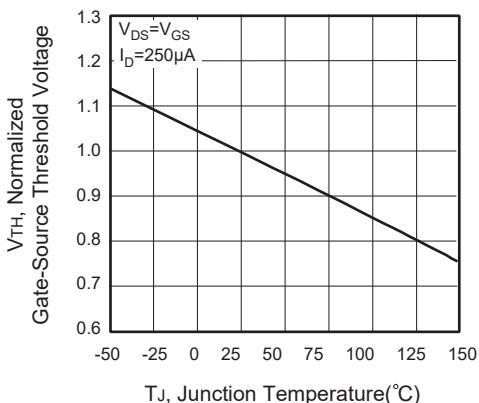
**Figure 2. Transfer Characteristics**



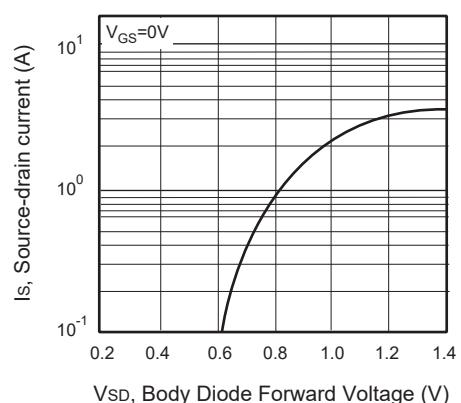
**Figure 3. Capacitance**



**Figure 4. On-Resistance Variation with Temperature**



**Figure 5. Gate Threshold Variation with Temperature**



**Figure 6. Body Diode Forward Voltage Variation with Source Current**

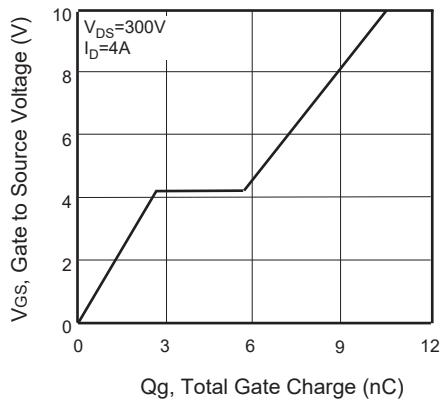


Figure 7. Gate Charge

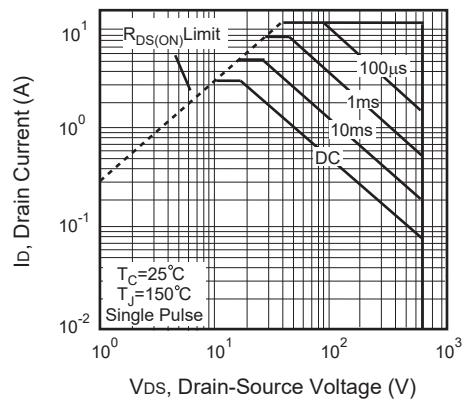


Figure 8. Maximum Safe  
Operating Area

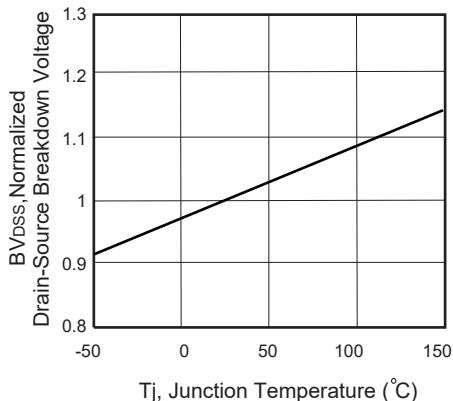


Figure 9. Breakdown Voltage Variation  
VS Temperature

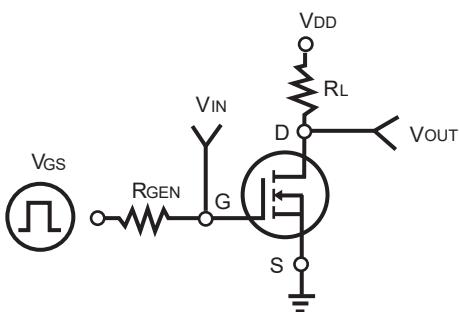


Figure 10. Switching Test Circuit

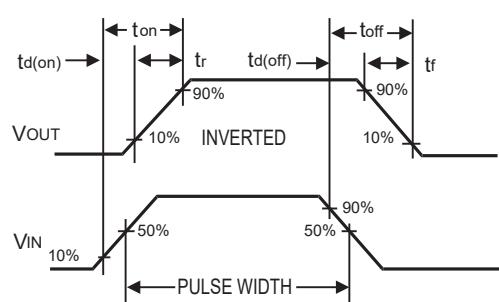


Figure 11. Switching Waveforms



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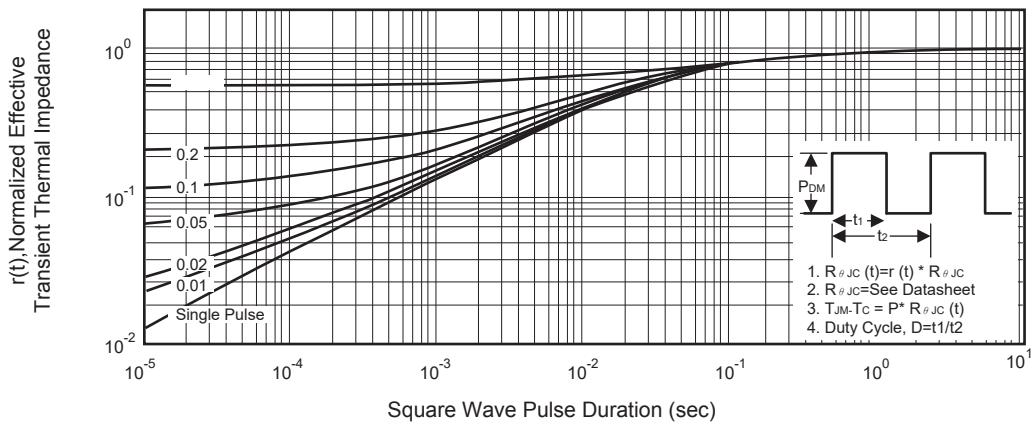


Figure 12. Normalized Thermal Transient Impedance Curve